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## SEALING PROBLEMS CHECKLIST FOR BLISTERS AND BLISTER CARDS

- I. Determine nature of the sealing difficulty
  - A. What is the strength of the seal?
    - 1. Does the blister fall off the card?
    - 2. Does the blister only pull ink off the card?
    - 3. Does the blister pull some board fiber from the card?
  - B. Are the blister card and blister compatible?
    - 1. What is the type of blister material?
    - 2. What is the type of adhesive coating used on the card?
    - 3. How old are the blister cards being used?
- II. Evaluate sealing equipment condition and settings.
  - A. What is the temperature of the sealing platen?
    - 1. Platen temperature should be between 290 ° F and 340° F. Start low and go higher if needed. Use surface thermometer on platen to insure accuracy.
  - B. What is the interface temperature?
    - 1. The interface temperature is the temperature achieved between the blister flange and the blister card during the heat seal process.
    - 2. Interface temperature should be between 190 ° F and 230 ° F. Start low and go higher if needed.
  - C. What is the dwell time (amount of time the platen is in direct contact with the blister card)?
    - 1. Dwell time should be between 2 to 4 seconds. Start low and go higher if needed.
  - D. What is the air line pressure to the equipment?
    - 1. The heat sealer must receive adequate pressure. We recommend approximately 100 pounds line pressure see manufacturer's manual for recommendations and limitations.
  - E. Is the heated platen in good condition?
    - 1. The platen should be perfectly flush or parallel to the sealing fixture to allow uniform pressure to be exerted around the perimeter of the sealing fixture.
    - 2. All platen heating elements should be checked to insure full and proper operation.
- III. Evaluate sealing fixture condition and placement.
  - A. Sealing fixture should be positioned close enough to the bottom surface of the heated platen, prior to activation, to obtain maximum pressure in down stroke. (see manufacturer's manual for recommendations)
  - B. The sealing fixture should be perfectly flush or parallel to the heated platen to allow for uniform pressure to be exerted around the perimeter of the sealing fixture.
  - C. The sealing fixture should be constructed of durable materials and supported such that it will not flex or bow during the sealing process.
  - D. Gas release channels may need to be incorporated into the sealing fixture to allow for quick release of moist, heated air created by the heat seal process.
  - E. The gasket material (coroprene, silicone rubber, etc.) on the sealing fixture should be in good condition.
  - F. Sealing cavity should not be so tight as to prevent the blister flange from easily resting on the sealing fixture gasket material.
- IV. For additional information and assistance
  - A. Contact your Andex Account Representative
  - B. Contact your equipment manufacturer.